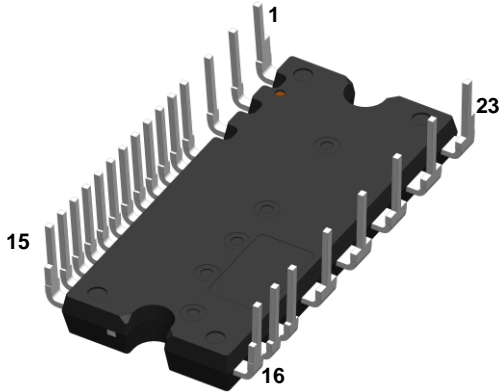


## External View



Size: 33.4 x 15 x 3.6 mm

## Features

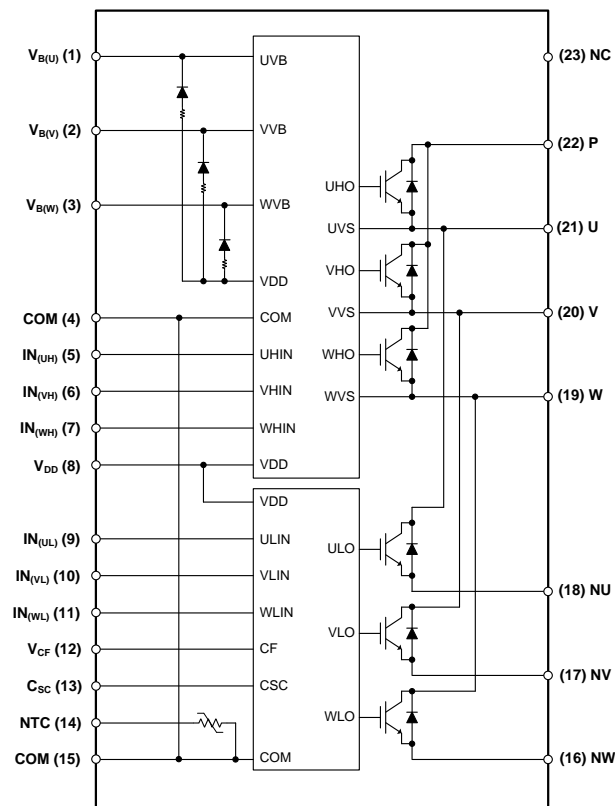
- 600V-15A (Trench Shielded Planar Gate IGBT)
- 3 phase Inverter module including HVIC drivers
- Built-in bootstrap diodes with integrated current-limiting resistor
- Control supply under-voltage lockout protection (UVLO)
- Over-temperature (OT) protection
- Temperature monitoring (NTC)
- Short-circuit current protection ( $C_{SC}$ )
- Controllable fault out signal ( $V_{CF}$ ) corresponding to SC, UV and OT fault
- Wide input interface (3-18V), Schmitt trigger receiver circuit (Active High)
- Isolation ratings of 2000Vrms/min



## Applications

- AC 100-240Vrms class low power motor drives
- Washing machines, Compressors, Fan Motors, Refrigerators, Dishwashers and Air-conditioners

## Internal Equivalent Circuit / Pin Configuration



## Ordering Information

| Part Number    | Temperature Range | Package | Pin Length Description |
|----------------|-------------------|---------|------------------------|
| AIP5N15K060Q4  | -40°C to 150°C    | IPM-5   | Normal                 |
| AIP5N15K060Q4S | -40°C to 150°C    | IPM-5A  | Short                  |



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant. Please visit [www.aosmd.com/media/AOSGreenPolicy.pdf](http://www.aosmd.com/media/AOSGreenPolicy.pdf) for additional information.

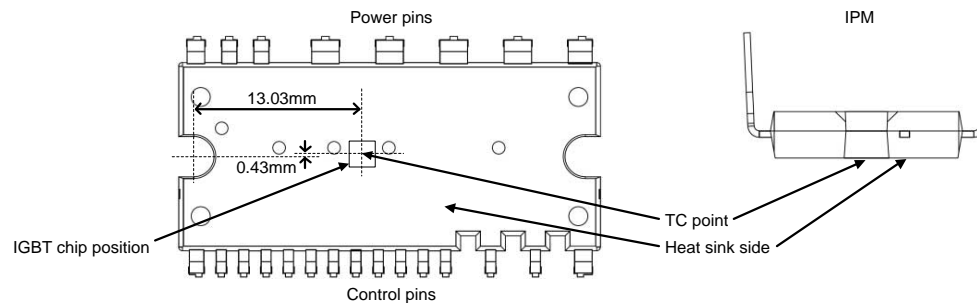
## Pin Description

| Pin Number | Pin Name    | Pin Function  |
|------------|-------------|---|
| 1          | $V_{B(U)}$  | High-Side Bias Voltage for U-Phase IGBT Driving                       |
| 2          | $V_{B(V)}$  | High-Side Bias Voltage for V-Phase IGBT Driving                       |
| 3          | $V_{B(W)}$  | High-Side Bias Voltage for W-Phase IGBT Driving                       |
| 4          | COM         | Common Supply Ground  |
| 5          | $IN_{(UH)}$ | Signal Input for High-Side U-Phase                                    |
| 6          | $IN_{(VH)}$ | Signal Input for High-Side V-Phase                                    |
| 7          | $IN_{(WH)}$ | Signal Input for High-Side W-Phase                                    |
| 8          | $V_{DD}$    | Common Bias Voltage for IC and IGBTs Driving                          |
| 9          | $IN_{(UL)}$ | Signal Input for Low-Side U-Phase                                     |
| 10         | $IN_{(VL)}$ | Signal Input for Low-Side V-Phase                                     |
| 11         | $IN_{(WL)}$ | Signal Input for Low-Side W-Phase                                     |
| 12         | $V_{CF}$    | Controllable Fault Output   |
| 13         | $C_{SC}$    | Capacitor (Low-Pass Filter) for Short-circuit Current Detection Input |
| 14         | NTC         | Thermistor (Temperature Monitoring)                                   |
| 15         | COM         | Common Supply Ground  |
| 16         | NW          | Negative DC-Link Input for W-Phase                                    |
| 17         | NV          | Negative DC-Link Input for V-Phase                                    |
| 18         | NU          | Negative DC-Link Input for U-Phase                                    |
| 19         | W           | Output for W-Phase  |
| 20         | V           | Output for V-Phase  |
| 21         | U           | Output for U-Phase  |
| 22         | P           | Positive DC-Link Input  |
| 23         | NC          | No Connection   |

## Absolute Maximum Ratings

$T_J = 25^\circ\text{C}$ , unless otherwise specified.

| Symbol                      | Parameter  | Conditions   | Ratings         | Units            |
|-----------------------------|--|--|-----------------|------------------|
| <b>Inverter</b>             |  |  |                 |                  |
| $V_{PN}$                    | Supply Voltage   | Applied between P - NU,NV,NW   | 450             | V                |
| $V_{PN(surge)}$             | Supply Voltage (surge)   | Applied between P - NU,NV,NW   | 500             | V                |
| $V_{CES}$                   | Collector-Emitter Voltage  |  | 600             | V                |
| $I_C$                       | Output Phase Current   | $T_C=25^\circ\text{C}$ , $T_J<150^\circ\text{C}$   | 15              | A                |
|                             |  | $T_C=100^\circ\text{C}$ , $T_J<150^\circ\text{C}$  | 7.5             | A                |
| $\pm I_{PK}$                | Output Peak Phase Current  | $T_C=25^\circ\text{C}$ , less than 1ms pulse width   | 30              | A                |
| $t_{SC}$                    | Short Circuit Withstand Time   | $V_{PN}\leq 400\text{V}$ , $T_J=150^\circ\text{C}$ , $V_{DD}=15\text{V}$   | 5               | $\mu\text{s}$    |
| $P_C$                       | Collector Dissipation  | $T_C=25^\circ\text{C}$ , per chip  | 28              | W                |
| $T_J$                       | Operating Junction Temperature   |  | -40 to 150      | $^\circ\text{C}$ |
| <b>Control (Protection)</b> |  |  |                 |                  |
| $V_{DD}$                    | Control Supply Voltage   | Applied between $V_{DD-COM}$   | 25              | V                |
| $V_{DB}$                    | High-Side Control Bias Voltage   | Applied between $V_{B(U)-U}$ , $V_{B(V)-V}$ , $V_{B(W)-W}$   | 25              | V                |
| $V_{IN}$                    | Input Voltage  | Applied between $IN_{(UH)}$ , $IN_{(VH)}$ , $IN_{(WH)}$ , $IN_{(UL)}$ , $IN_{(VL)}$ , $IN_{(WL)} - COM$          | $V_{DD}\pm 0.5$ | V                |
| $V_{CF}$                    | Fault Output Supply Voltage  | Applied between $V_{CF-COM}$   | $5\pm 0.5$      | V                |
| $I_{CF}$                    | Fault Output Current   | Sink current at $V_{CF}$ terminal  | 1               | mA               |
| $V_{SC}$                    | Current Sensing Input Voltage  | Applied between $C_{SC-COM}$   | $5\pm 0.5$      | V                |
| <b>Total System</b>         |  |  |                 |                  |
| $V_{PN(PROT)}$              | Self Protection Supply Voltage Limit (Short-Circuit Protection Capability) | $V_{DD}=13.5-16.5\text{V}$ , Inverter part<br>$T_J=150^\circ\text{C}$ , Non-repetitive, less than $2\mu\text{s}$ | 400             | V                |
| $T_C$                       | Module Case Operation Temperature  | Measurement point of $T_C$ is provided in Figure 1   | -30 to 125      | $^\circ\text{C}$ |
| $T_{STG}$                   | Storage Temperature  |  | -40 to 150      | $^\circ\text{C}$ |
| $V_{ISO}$                   | Isolation Voltage  | 60Hz, sinusoidal, AC 1min, between connected all pins and heat sink plate  | 2000            | $V_{rms}$        |



**Figure 1.  $T_C$  Measurement Point**

## Thermal Resistance

| Symbol         | Parameter  | Conditions                     | Min. | Typ. | Max. | Units |
|----------------|--|--------------------------------|------|------|------|-------|
| $R_{th(j-c)Q}$ | Junction to Case Thermal Resistance <sup>(1)</sup> | Inverter IGBT (per 1/6 module) | -    | -    | 4.5  | K/W   |
| $R_{th(j-c)F}$ |  | Inverter FWD (per 1/6 module)  | -    | -    | 6.9  | K/W   |

**Note:**

- For the measurement point of case temperature ( $T_C$ ), please refer to Figure 1.

## Electrical Characteristics

$T_J = 25^\circ\text{C}$ , unless otherwise specified.

| Symbol                      | Parameter                                  | Conditions  |  | Min. | Typ. | Max. | Units            |
|-----------------------------|--|---|--|------|------|------|------------------|
| <b>Inverter</b>             |  |   |  |      |      |      |                  |
| $V_{CE(SAT)}$               | Collector-Emitter Saturation Voltage       | $V_{DD}=V_{DB}=15V$ ,<br>$V_{IN}=5V$  | $I_C=7.5A$ , $T_J=25^\circ\text{C}$                        | -    | 1.60 | 2.00 | V                |
|                             |  |   | $I_C=7.5A$ , $T_J=125^\circ\text{C}$                       | -    | 1.90 | -    | V                |
| $V_F$                       | FWD Forward Voltage                        | $V_{IN}=0$  | $I_F=7.5A$ , $T_J=25^\circ\text{C}$                        | -    | 1.55 | 2.00 | V                |
| $t_{ON}$                    | Switching Times                            | $V_{PN}=300V$ , $V_{DD}=V_{DB}=15V$<br>$I_C=7.5A$ , $T_J=25^\circ\text{C}$ , $V_{IN}=0V \leftrightarrow 5V$<br>Inductive load (high-side) |  | 0.40 | 0.70 | 1.20 | $\mu\text{s}$    |
| $t_{C(ON)}$                 |  |   |  | -    | 0.10 | 0.40 | $\mu\text{s}$    |
| $t_{OFF}$                   |  |   |  | -    | 1.00 | 1.50 | $\mu\text{s}$    |
| $t_{C(OFF)}$                |  |   |  | -    | 0.10 | 0.30 | $\mu\text{s}$    |
| $t_{rr}$                    |  |   |  | -    | 0.10 | -    | $\mu\text{s}$    |
| $I_{CES}$                   | Collector-Emitter Leakage Current          | $V_{CE}=V_{CES}$  | $T_J=25^\circ\text{C}$                                     | -    | -    | 1    | mA               |
|                             |  |   | $T_J=125^\circ\text{C}$                                    | -    | -    | 10   | mA               |
| <b>Control (Protection)</b> |  |   |  |      |      |      |                  |
| $I_{QDD}$                   | Quiescent $V_{DD}$ Supply Current          | $V_{DD}=15V$ ,<br>$I_{N(UH,VH,WH,UL,VL,WL)}=0V$   | $V_{DD-COM}$   | -    | -    | 2.1  | mA               |
| $I_{QDB}$                   | Quiescent $V_{DB}$ Supply Current          | $V_{DB}=15V$ ,<br>$I_{N(UH, VH, WH)}=0V$  | $V_{B(U)-U}$ , $V_{B(V)-V}$ , $V_{B(W)-W}$                 | -    | -    | 0.3  | mA               |
| $V_{SC(ref)}$               | Short-Circuit Trip Level                   | $V_{DD}=15V^{(2)}$  |  | 0.45 | 0.48 | 0.51 | V                |
| $UV_{DT}$                   | Supply Circuit Under-Voltage Protection    |   | Trip Level   | 10.3 | 11.4 | 12.5 | V                |
| $UV_{DR}$                   |  |   | Reset Level  | 10.8 | 11.9 | 13.0 | V                |
| $UV_{DBT}$                  |  |   | Trip Level   | 8.5  | 9.5  | 10.5 | V                |
| $UV_{DBR}$                  |  |   | Reset Level  | 9.5  | 10.5 | 11.5 | V                |
| $OT_T$                      | Over-Temperature Protection <sup>(3)</sup> | $V_{DD}=15V$ , Detect LVIC Temperature  | Trip Level   | 110  | 130  | 150  | $^\circ\text{C}$ |
| $OT_{HYS}$                  |  |   | Hysteresis of Trip Reset                                   | -    | 30   | -    | $^\circ\text{C}$ |
| $V_{CFH}$                   | Fault Output Voltage                       | $V_{SC}=0V$ , $V_{CF}$ Circuit: 10k $\Omega$ to 5V pull-up  |  | 4.9  | -    | -    | V                |
| $V_{CFL}$                   |  |   | $V_{SC}=1V$ , $V_{CF}$ Circuit: 10k $\Omega$ to 5V pull-up | -    | -    | 0.5  | V                |
| $V_{CF+}$                   | CF positive going threshold                |   |  | -    | 1.9  | 2.2  | V                |
| $V_{CF-}$                   | CF negative going threshold                |   |  | 0.8  | 1.1  | -    | V                |
| $t_{FO}$                    | Fault Output Pulse Width <sup>(4)</sup>    |   |  | 20   | -    | -    | $\mu\text{s}$    |
| $I_{IN}$                    | Input Current                              | $V_{IN}=5V$   |  | -    | 1.0  | -    | mA               |
| $V_{th(on)}$                | ON Threshold Voltage                       | Applied between $I_{N(UH)}$ , $I_{N(VH)}$ , $I_{N(WH)}$ , $I_{N(UL)}$ ,<br>$I_{N(VL)}$ , $I_{N(WL)}-COM$                                  |  |      | 2.3  | 2.6  | V                |
| $V_{th(off)}$               | OFF Threshold Voltage                      |   |  | 0.8  | 1.2  |      | V                |
| $V_{th(hys)}$               | ON/OFF Threshold Hysteresis Voltage        |   |  | -    | 1.1  | -    | V                |
| $V_{F(BSD)}$                | Bootstrap Diode Forward Voltage            | $I_F=10mA$ Including Voltage Drop by Limiting Resistor <sup>(5)</sup>   |  | 0.5  | 1.0  | 1.5  | V                |
| $R_{BSD}$                   | Built-in Limiting Resistance               | Included in Bootstrap Diode   |  | 80   | 100  | 120  | $\Omega$         |

### Notes:

- Short-circuit protection works only for low sides.
- When the LVIC temperature exceeds OT Trip temperature level ( $OT_T$ ), OT protection is triggered and fault outputs.
- Fault signal ( $F_O$ ) outputs when SC, UV or OT protection is triggered.  $F_O$  pulse width is different for each protection mode. At SC failure,  $F_O$  pulse width is a fixed width (minimum 20 $\mu\text{s}$ ), but at UV or OT failure,  $F_O$  outputs continuously until recovering from UV or OT state. (But minimum  $F_O$  pulse width is 20 $\mu\text{s}$ ).
- The characteristics of bootstrap diodes are described in Figure 2.

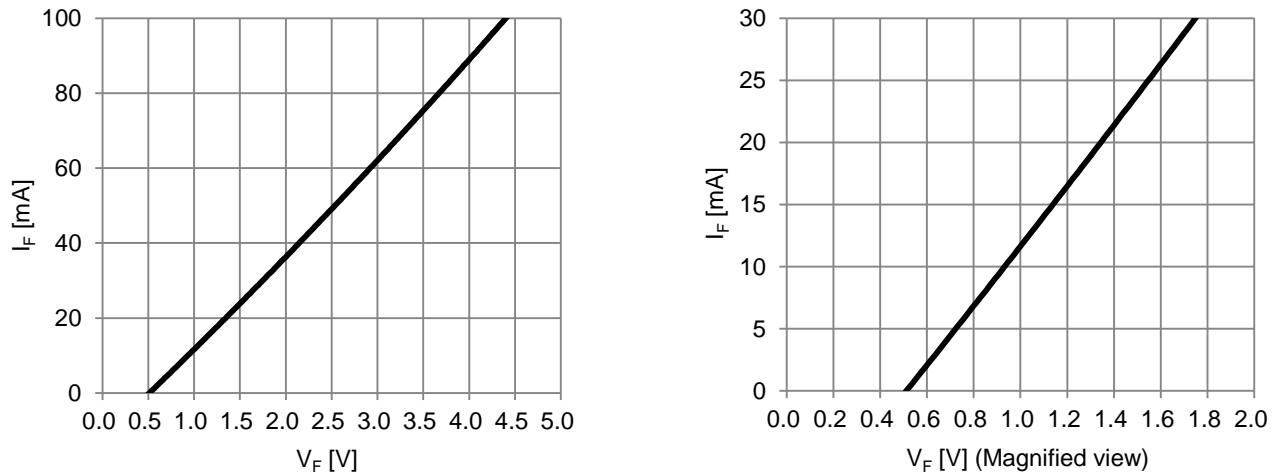


Figure 2. Built-in Bootstrap Diode  $V_F$ - $I_F$  Characteristic (@ $T_A=25^\circ\text{C}$ )

### NTC Thermistor

| Symbol    | Parameter  | Conditions                 | Min. | Typ.  | Max. | Units     |
|-----------|------------|----------------------------|------|-------|------|-----------|
| $R_{25}$  | Resistance | $T_{NTC}=25^\circ\text{C}$ | -    | 84.83 | -    | $k\Omega$ |
| B(25/100) | C-constant |                            | -    | 4092  | -    | K         |

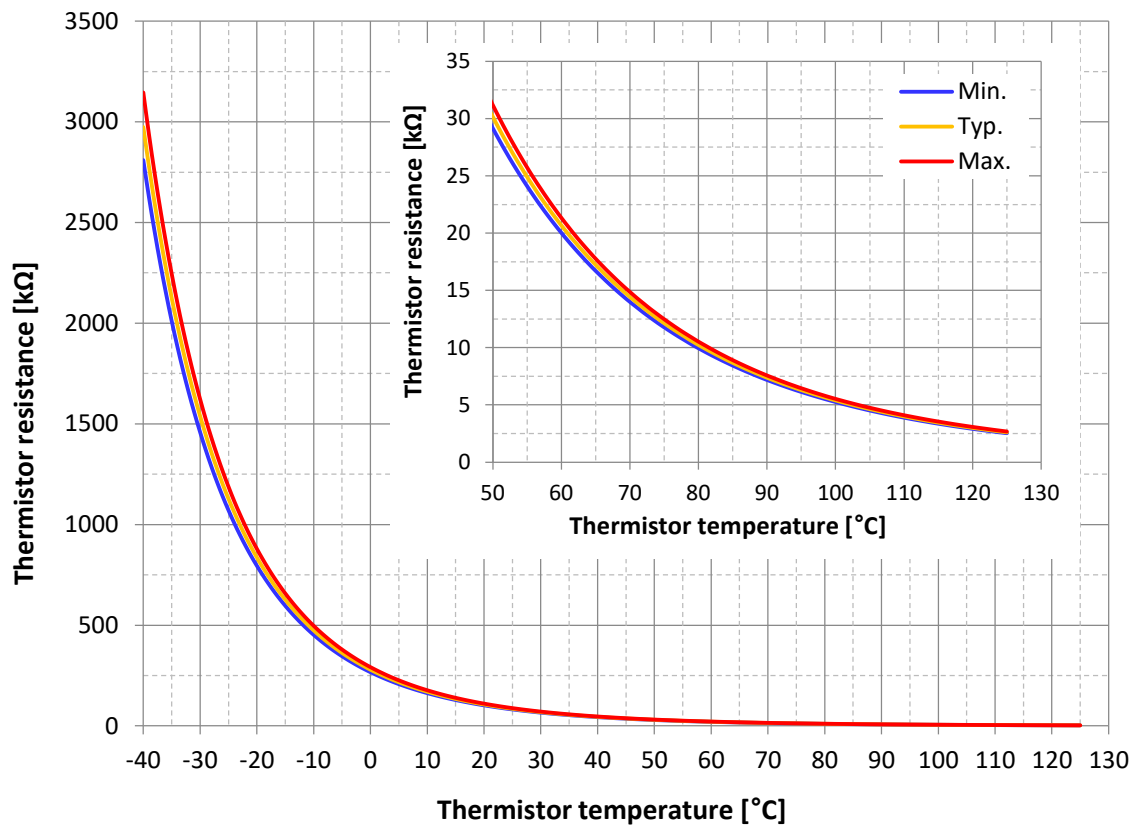


Figure 3. Thermistor Resistance vs. Temperature Curve

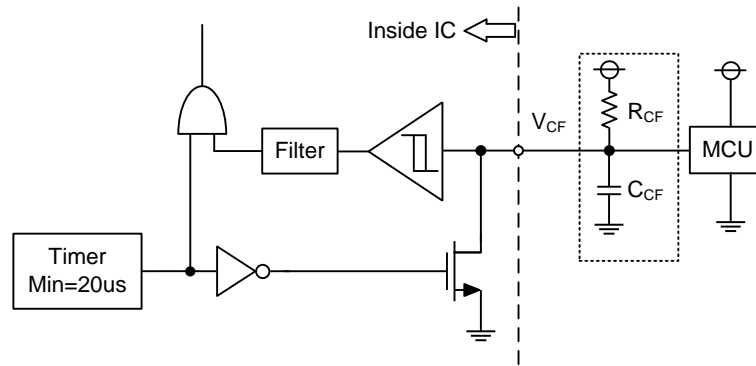


Figure 4.  $V_{CF}$  Output Circuit

- (1) The  $V_{CF}$  pin provides an enable functionality that allows it to shut down the all low-side IGBTs. When the  $V_{CF}$  pin is in the high state the IPM is able to operate normally. If the  $V_{CF}$  pin is in a low state, the low-side IGBTs are turned off until the enable condition is restored. In addition, the  $V_{CF}$  pin can provide the fault output signal with the fixed or controlled fault out pulse width.
- (2) If only a pull-up resistor of 10k $\Omega$  connected to the  $V_{CF}$  pin, the fault output pulse width is fixed at minimum 20us.
- (3) If a capacitor is connected with a pull-up resistor together, the fault output pulse width can be controlled according to the resistor and the capacitor values. The length of fault output pulse width is determined by the following formula ;
  - $t_{FO} = -(R_{CF} \cdot C_{CF}) \cdot \ln(1 - V_{CF+}/V_{DD}) + 20\text{us}(\text{min.})$
  - ex)  $V_{DD}=5\text{V}$ ,  $R_{CF}=2.2\text{M}\Omega$ ,  $C_{CF}=1\text{nF}$ ,  $t_{FO}\approx 1.07\text{ms}$ . Recommended parameters in the design are  $C_{CF}$  of  $\leq 1\text{nF}$  and  $R_{CF}$  of 0.1M to 2.2M $\Omega$ .

## Mechanical Characteristics and Ratings

| Symbol          | Parameter                         | Conditions | Min. | Typ. | Max. | Units |
|-----------------|-----------------------------------|------------|------|------|------|-------|
| Mounting Torque | Mounting Screw: M3 <sup>(6)</sup> |            | 0.59 | 0.69 | 0.78 | N m   |
| Weight          |                                   |            | -    | 5.25 | -    | g     |
| Flatness        | Refer to Figure 5                 |            | -50  | -    | 100  | μm    |

**Note:**

6. Plain washers (ISO 7089-7094) are recommended.

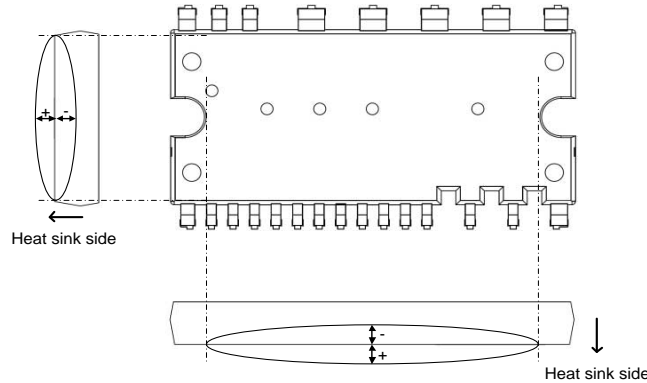


Figure 5. Flatness Measurement Positions

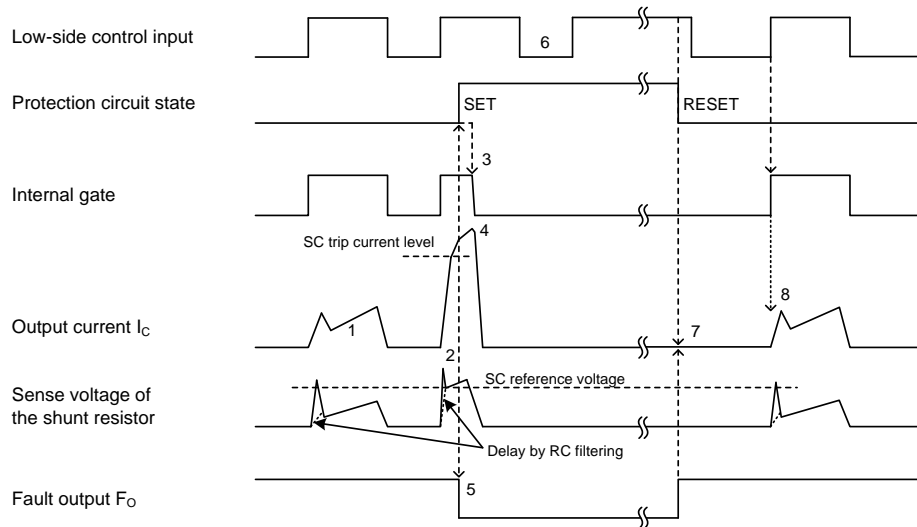
## Recommended Operation Conditions

| Symbol                         | Parameter                                | Conditions  | Min. | Typ. | Max. | Units |
|--------------------------------|--|---|------|------|------|-------|
| $V_{PN}$                       | Supply Voltage                           | Applied between P-NU, NV, NW                                | 0    | 300  | 400  | V     |
| $V_{DD}$                       | Control Supply Voltage                   | Applied between $V_{DD}$ -COM                               | 13.5 | 15.0 | 16.5 | V     |
| $V_{DB}$                       | High-Side Bias Voltage                   | Applied between $V_{B(U)}$ -U, $V_{B(V)}$ -V, $V_{B(W)}$ -W | 13.5 | 15.0 | 18.5 | V     |
| $dV_{DD}/dt$ ,<br>$dV_{DB}/dt$ | Control Supply Variation                 |   | -1   | -    | 1    | V/μs  |
| $t_{dead}$                     | Arm Shoot-Through Blocking Time          | For each input signal                                       | 1.0  | -    | -    | μs    |
| $f_{PWM}$                      | PWM Input Frequency                      | $-40^{\circ}\text{C} < T_J < 150^{\circ}\text{C}$           | -    | -    | 20   | kHz   |
| $PW_{IN(ON)}$                  | Minimum Input Pulse Width <sup>(7)</sup> |   | 0.5  | -    | -    | μs    |
| $PW_{IN(OFF)}$                 |  |   | 0.5  | -    | -    | μs    |
| COM                            | COM Variation                            | Between COM-NU, NV, NW (including surge)                    | -5.0 | -    | 5.0  | V     |

**Note:**

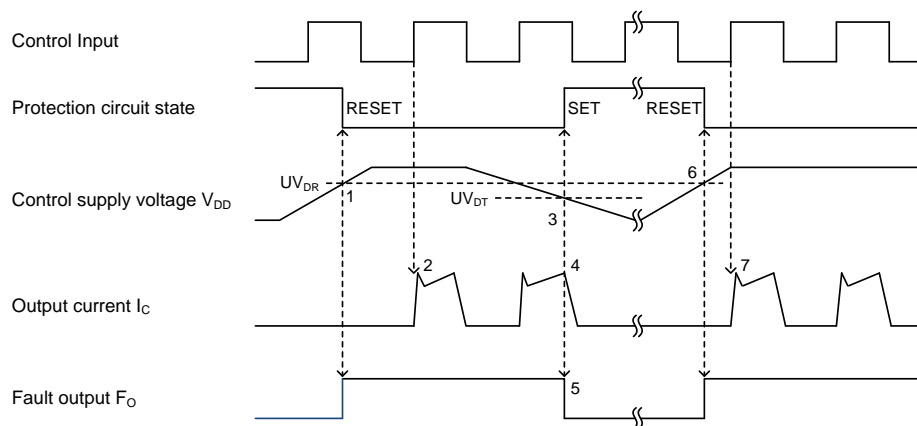
7. IPM may not respond if the input pulse width is less than  $PW_{IN(ON)}$ ,  $PW_{IN(OFF)}$ .

## Time Charts of the IPM Protective Function



**Figure 6. Short-Circuit Protection  
(Low-side Operation Only with the External Shunt Resistor and RC Filter)**

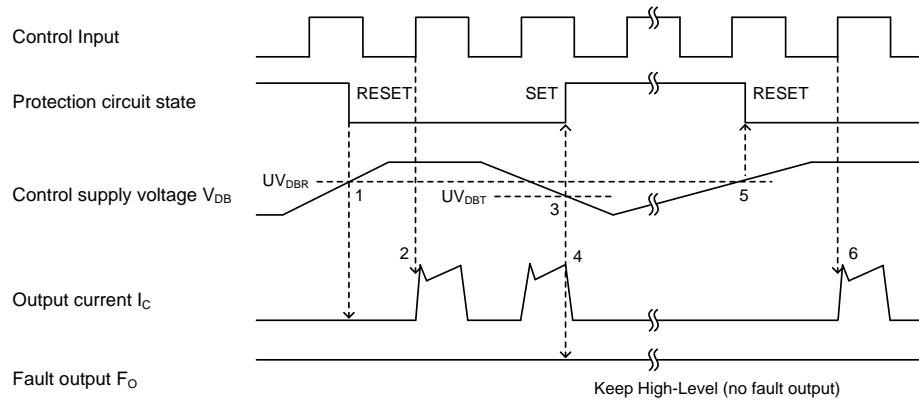
- (1) Normal operation: IGBT turns on and outputs current.
- (2) Short-circuit current detection (SC triggered).
- (3) All low-side IGBTs' gates are hard interrupted.
- (4) All low-side IGBTs turn OFF.
- (5)  $F_O$  output time ( $t_{FO}$ )=minimum 20 $\mu$ s.
- (6) Input = "L" : IGBT OFF.
- (7) Fault output finishes, but output current will not turn on until next ON signal (L→H).
- (8) Normal operation: IGBT turns on and outputs current.



**Figure 7. Under-Voltage Protection (Low-side, UV<sub>D</sub>)**

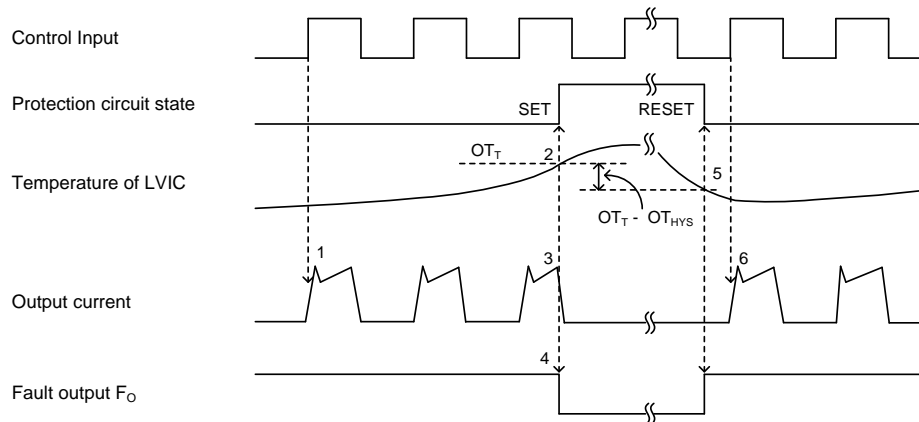
- (1) Control supply voltage  $V_{DD}$  exceeds under voltage reset level ( $UV_{DR}$ ), but IGBT turns on by next ON signal (L→H).
- (2) Normal operation: IGBT turns on and outputs current.
- (3)  $V_{DD}$  level drops to under voltage trip level ( $UV_{DT}$ ).
- (4) All low-side IGBTs turn OFF regardless of control input condition.
- (5)  $F_O$  output time ( $t_{FO}$ )=minimum 20 $\mu$ s, and  $F_O$  stays low as long as  $V_{DD}$  is below  $UV_{DR}$ .
- (6)  $V_{DD}$  level reaches  $UV_{DR}$ .
- (7) Normal operation: IGBT turns on and outputs current.





**Figure 8. Under-Voltage Protection (High-side,  $UV_{DB}$ )**

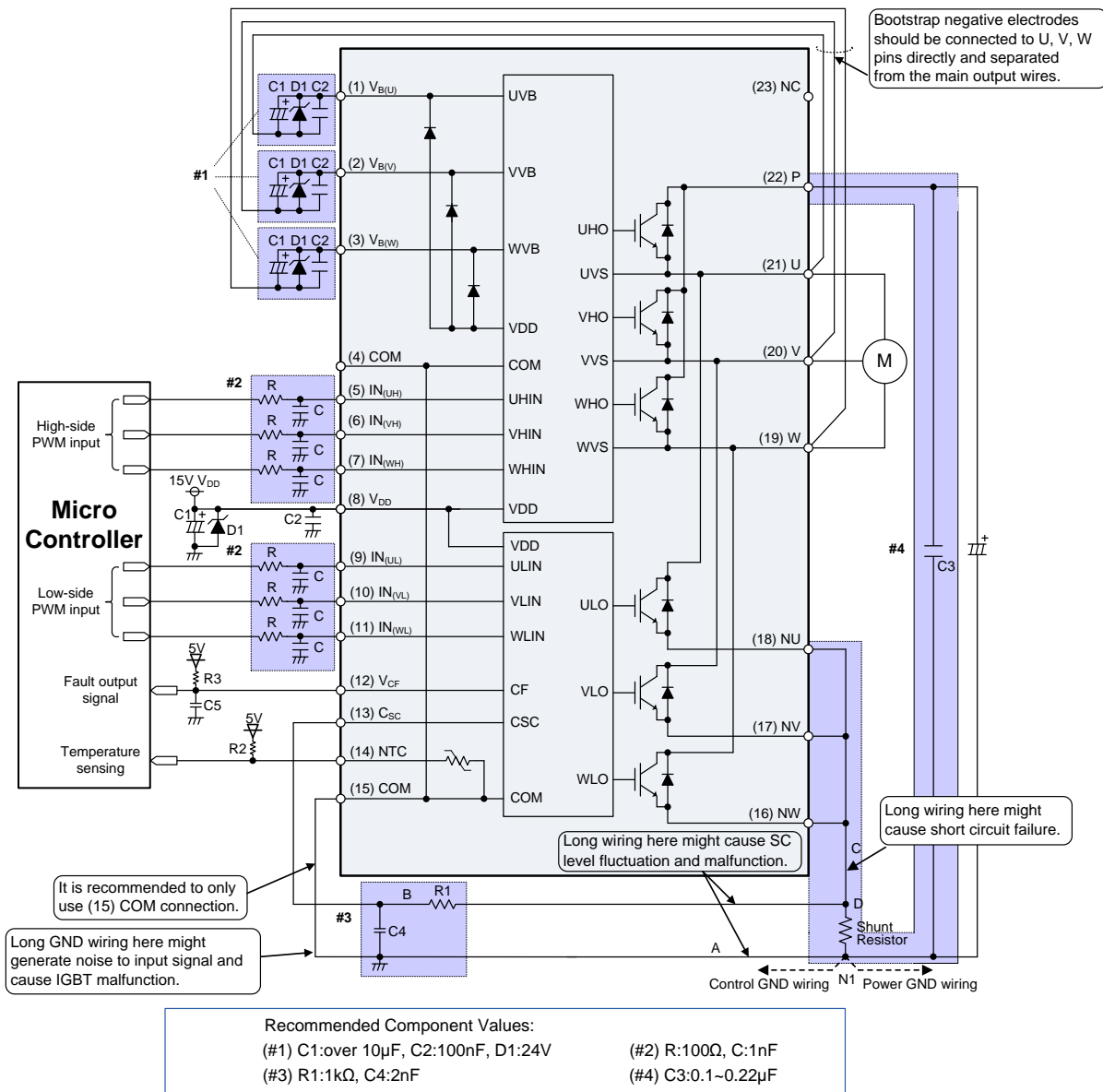
- (1) Control supply voltage  $V_{DB}$  rises. After the voltage reaches under voltage reset level  $UV_{DBR}$ , IGBT turns on by next ON signal (L→H).
- (2) Normal operation: IGBT turns on and outputs current.
- (3)  $V_{DB}$  level drops to under voltage trip level ( $UV_{DBT}$ ).
- (4) All high-side IGBTs turn OFF regardless of control input condition, but there is no  $F_O$  signal output.
- (5)  $V_{DB}$  level reaches  $UV_{DBR}$ .
- (6) Normal operation: IGBT turns on and outputs current.



**Figure 9. Over-Temperature Protection (Low-side, Detecting LVIC Temperature)**

- (1) Normal operation: IGBT turns on and outputs current.
- (2) LVIC temperature exceeds over-temperature trip level ( $OT_T$ ).
- (3) All low-side IGBTs turn off regardless of control input condition.
- (4)  $F_O$  output time ( $t_{FO}$ )=minimum  $20\mu s$ , and  $F_O$  stays low as long as LVIC temperature is over  $OT_T$ .
- (5) LVIC temperature drops to over-temperature reset level ( $OT_T - OT_{HYS}$ ).
- (6) Normal operation: IGBT turns on by the next ON signal (L→H).

## Example of Application Circuit



- (1) If the control GND is connected with the power GND by common broad pattern, it may cause malfunction by power GND fluctuation. It is recommended to connect the control GND and power GND at a single point (N1), near the terminal of the shunt resistor.
- (2) There are two COM pins in the IPM but it is recommended to only use the (15) COM pin to minimize SC detection noise.
- (3) A zener diode D1 (24V/1W) is recommended between each pair of control supply pins to prevent surge destruction.
- (4) Prevention of surge destruction can further be improved by placing the bus capacitor as close to pin P and N1 as possible. Generally a 0.1-0.22 $\mu$ F snubber capacitor C3 between the P-N1 terminals is recommended.
- (5) Selection of the R1\*C4 filter components for short-circuit protection is recommended to have tight tolerance, and is temperature-compensated type. The R1\*C4 time constant should be set such that SC current is shut down within 2 $\mu$ s; (typically 1.5-2 $\mu$ s). R1 and C4 should be placed as close as possible to the C<sub>SC</sub> pin. SC interrupting time may vary with layout patterns and components selection, therefore thorough evaluation in the system is necessary.
- (6) NTC signal line should be pull up to the positive side of the 5V/3.3V logic power supply with a proper resistor R2.
- (7) To prevent malfunction, traces A, B, and C should be as short as possible.
- (8) It is recommended that all capacitors are mounted as close to the IPM as possible. (C1: electrolytic type with good temperature and frequency characteristics. C2: ceramic type with 0.1-2 $\mu$ F, good temperature, frequency and DC bias characteristics.)

- (9) Input drives are active-high. There is a minimum 3.5kΩ pull-down resistor in the input circuit of IC. To prevent malfunction, the layout to each input should be as short as possible. When using RC coupling circuit, make sure the input signal levels meet the required turn-on and turn-off threshold voltages.
- (10)  $V_{CF}$  output is open drain type. It should be pulled up to MCU or control power supply (max=  $5\pm 0.5V$ ), limiting the current ( $I_{CF}$ ) to no more than 1mA.  $I_{CF}$  is estimated roughly by the formula of control power supply voltage divided by the pull-up resistor R3. For example, if control supply is 5V, a 10kΩ (over 5kΩ) pull-up resistor R3 is recommended.
- (11) If only a pull-up resistor R3 of 10kΩ connected to  $V_{CF}$  pin, the fault output pulse width is fixed at minimum 20us. If a capacitor C5 is connected with a pull-up resistor R3, the fault output pulse width can be controlled according to the resistor value and capacitor value. For the design guide, please refer to the Figure 4.
- (12) Direct drive of the IPM from the MCU is possible without having to use opto-coupler or isolation transformer.
- (13) The IPM may malfunction and erroneous operations may occur if high frequency noise is superimposed to the supply line. To avoid such problems, line ripple voltage is recommended to have  $dV/dt \leq \pm 1V/\mu s$ , and  $V_{ripple} \leq 2V_{p-p}$ .
- (14) It is not recommended to use the IPM to drive the same load in parallel with another IPM or inverter types.

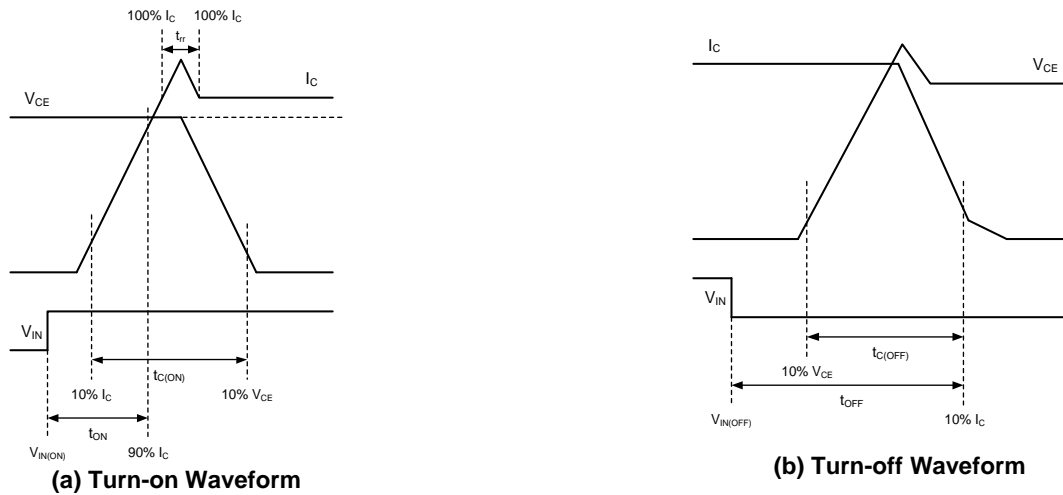
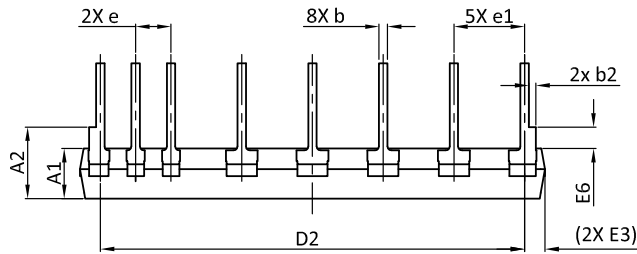
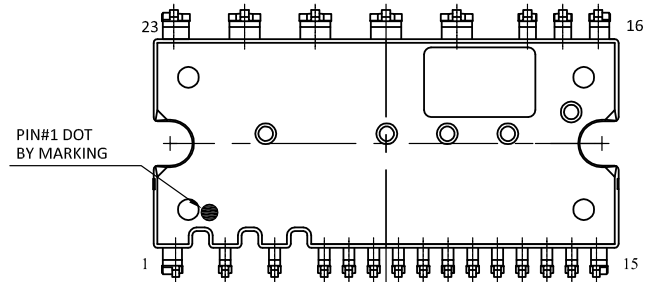


Figure 10. Switching Times Definition

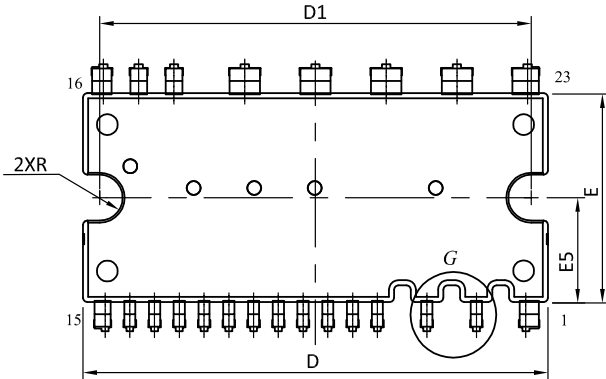
Package Dimensions, IPM-5



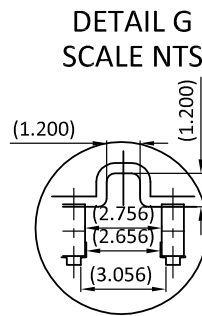
SIDE VIEW



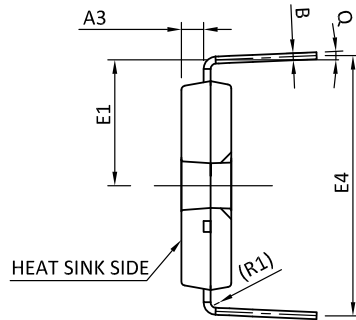
BOTTOM VIEW



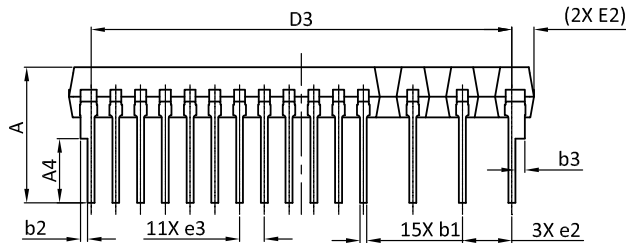
TOP VIEW



DETAIL G  
SCALE NTS

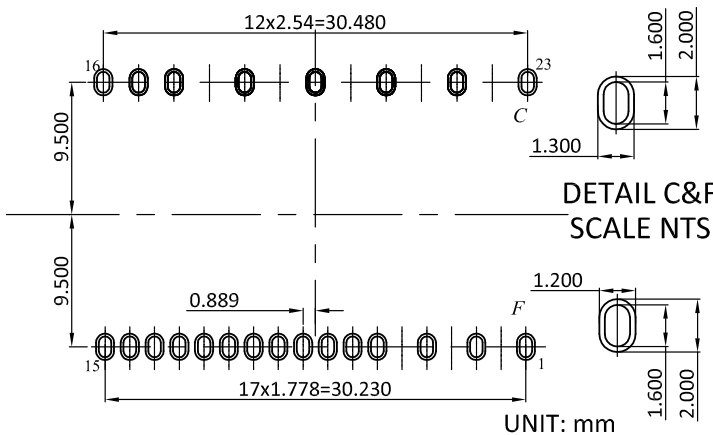


SIDE VIEW



SIDE VIEW

LAND PATTERN RECOMMENDATIONS



DETAIL C&F  
SCALE NTS

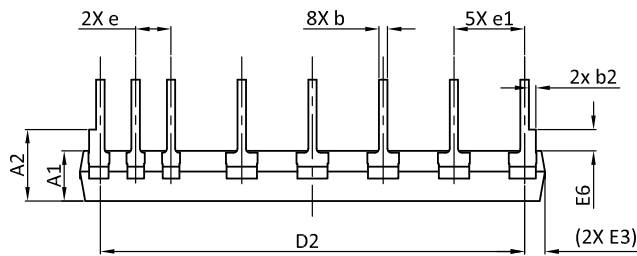
UNIT: mm

| SYMBOLS | DIMENSION IN MILLIMETRES |        |        | DIMENSION IN INCHS |       |       |
|---------|--------------------------|--------|--------|--------------------|-------|-------|
|         | MIN.                     | NOM.   | MAX.   | MIN.               | NOM.  | MAX.  |
| A       | 9.300                    | 9.700  | 10.100 | 0.366              | 0.382 | 0.398 |
| A1      | 3.300                    | 3.600  | 3.900  | 0.130              | 0.142 | 0.154 |
| A2      | 4.700                    | 5.100  | 5.500  | 0.185              | 0.201 | 0.217 |
| A3      | 1.500                    | 1.600  | 1.700  | 0.059              | 0.063 | 0.067 |
| A4      | 4.200                    | 4.600  | 5.000  | 0.165              | 0.181 | 0.197 |
| B       | 0.400                    | 0.500  | 0.600  | 0.016              | 0.020 | 0.024 |
| b       | 0.500                    | 0.600  | 0.700  | 0.020              | 0.024 | 0.028 |
| b1      | 0.400                    | 0.500  | 0.600  | 0.016              | 0.020 | 0.024 |
| b2      | 0.400                    | 0.500  | 0.600  | 0.016              | 0.020 | 0.024 |
| b3      | 0.600                    | 0.700  | 0.800  | 0.024              | 0.028 | 0.031 |
| D       | 33.100                   | 33.400 | 33.700 | 1.303              | 1.315 | 1.327 |
| D1      | 30.800                   | 31.000 | 31.200 | 1.213              | 1.220 | 1.228 |
| D2      | 30.180                   | 30.480 | 30.780 | 1.188              | 1.200 | 1.212 |
| D3      | 29.930                   | 30.230 | 30.530 | 1.178              | 1.190 | 1.202 |
| E       | 14.700                   | 15.000 | 15.300 | 0.579              | 0.591 | 0.602 |
| E1      | 8.600                    | 9.000  | 9.400  | 0.339              | 0.354 | 0.370 |
| E2      | 1.600REF                 |        |        | 0.063REF           |       |       |
| E3      | 1.500REF                 |        |        | 0.059REF           |       |       |
| E4      | 18.300                   | 18.700 | 19.100 | 0.720              | 0.736 | 0.752 |
| E5      | 7.300                    | 7.500  | 7.700  | 0.287              | 0.295 | 0.303 |
| E6      | 1.100                    | 1.500  | 1.900  | 0.043              | 0.059 | 0.075 |
| e       | 2.340                    | 2.540  | 2.740  | 0.092              | 0.100 | 0.108 |
| e1      | 4.880                    | 5.080  | 5.280  | 0.192              | 0.200 | 0.208 |
| e2      | 3.356                    | 3.556  | 3.756  | 0.132              | 0.140 | 0.148 |
| e3      | 1.578                    | 1.778  | 1.978  | 0.062              | 0.070 | 0.078 |
| R       | 1.500                    | 1.600  | 1.700  | 0.059              | 0.063 | 0.067 |
| R1      | 0.400REF                 |        |        | 0.016REF           |       |       |
| Q       | 2° - 6°                  |        |        | 2° - 6°            |       |       |

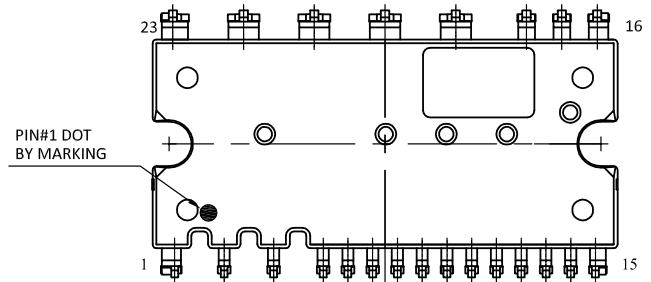
NOTES

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS, MOLD FLASH SHOULD BE LESS THAN 6 MIL.
2. TOLERANCE 0.100 MILLIMETERS UNLESS OTHERWISE SPECIFIED.
3. CONTROLLING DIMENSION IS MILLIMETER, CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.
4. ( ) IS REFERENCE.

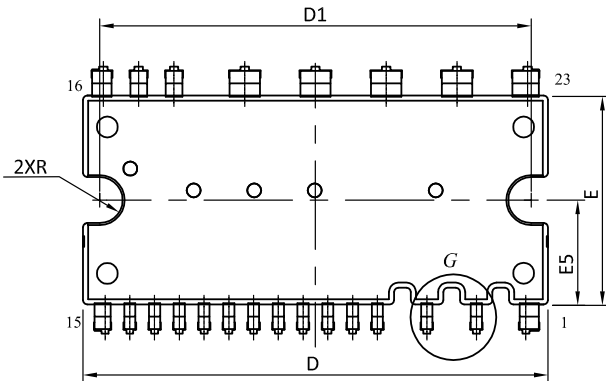
Package Dimensions, IPM-5A



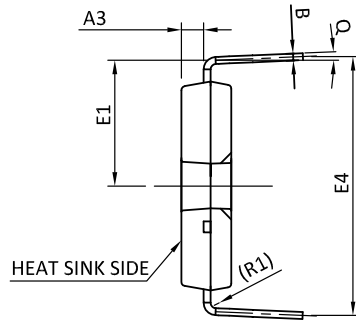
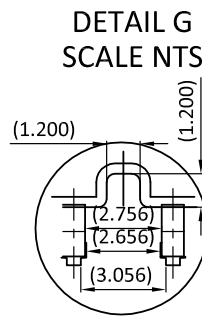
SIDE VIEW



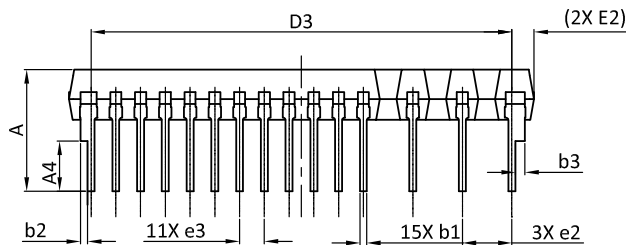
BOTTOM VIEW



TOP VIEW

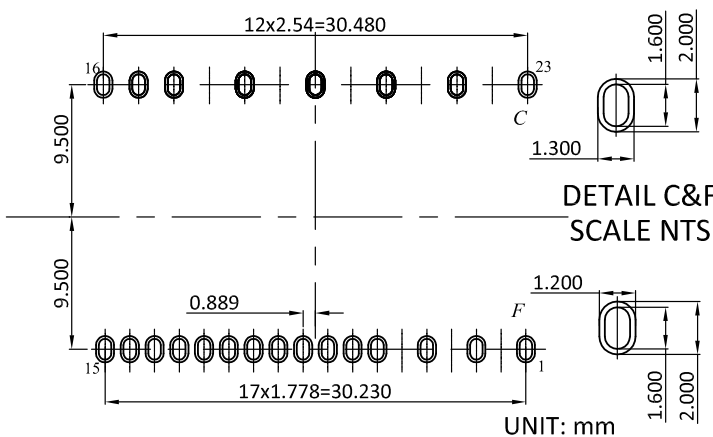


SIDE VIEW



SIDE VIEW

LAND PATTERN RECOMMENDATIONS



DETAIL C&F  
SCALE NTS

UNIT: mm

| SYMBOLS | DIMENSION IN MILLIMETRES |        |        | DIMENSION IN INCHS |       |       |
|---------|--------------------------|--------|--------|--------------------|-------|-------|
|         | MIN.                     | NOM.   | MAX.   | MIN.               | NOM.  | MAX.  |
| A       | 8.300                    | 8.700  | 9.100  | 0.327              | 0.343 | 0.358 |
| A1      | 3.300                    | 3.600  | 3.900  | 0.130              | 0.142 | 0.154 |
| A2      | 4.700                    | 5.100  | 5.500  | 0.185              | 0.201 | 0.217 |
| A3      | 1.500                    | 1.600  | 1.700  | 0.059              | 0.063 | 0.067 |
| A4      | 3.200                    | 3.600  | 4.000  | 0.126              | 0.142 | 0.157 |
| B       | 0.400                    | 0.500  | 0.600  | 0.016              | 0.020 | 0.024 |
| b       | 0.500                    | 0.600  | 0.700  | 0.020              | 0.024 | 0.028 |
| b1      | 0.400                    | 0.500  | 0.600  | 0.016              | 0.020 | 0.024 |
| b2      | 0.400                    | 0.500  | 0.600  | 0.016              | 0.020 | 0.024 |
| b3      | 0.600                    | 0.700  | 0.800  | 0.024              | 0.028 | 0.031 |
| D       | 33.100                   | 33.400 | 33.700 | 1.303              | 1.315 | 1.327 |
| D1      | 30.800                   | 31.000 | 31.200 | 1.213              | 1.220 | 1.228 |
| D2      | 30.180                   | 30.480 | 30.780 | 1.188              | 1.200 | 1.212 |
| D3      | 29.930                   | 30.230 | 30.530 | 1.178              | 1.190 | 1.202 |
| E       | 14.700                   | 15.000 | 15.300 | 0.579              | 0.591 | 0.602 |
| E1      | 8.600                    | 9.000  | 9.400  | 0.339              | 0.354 | 0.370 |
| E2      | 1.600REF                 |        |        | 0.063REF           |       |       |
| E3      | 1.500REF                 |        |        | 0.059REF           |       |       |
| E4      | 18.200                   | 18.600 | 19.000 | 0.717              | 0.732 | 0.748 |
| E5      | 7.300                    | 7.500  | 7.700  | 0.287              | 0.295 | 0.303 |
| E6      | 1.100                    | 1.500  | 1.900  | 0.043              | 0.059 | 0.075 |
| e       | 2.340                    | 2.540  | 2.740  | 0.092              | 0.100 | 0.108 |
| e1      | 4.880                    | 5.080  | 5.280  | 0.192              | 0.200 | 0.208 |
| e2      | 3.356                    | 3.556  | 3.756  | 0.132              | 0.140 | 0.148 |
| e3      | 1.578                    | 1.778  | 1.978  | 0.062              | 0.070 | 0.078 |
| R       | 1.500                    | 1.600  | 1.700  | 0.059              | 0.063 | 0.067 |
| R1      | 0.400REF                 |        |        | 0.016REF           |       |       |
| Q       | 2° - 6°                  |        |        | 2° - 6°            |       |       |

NOTES

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2. TOLERANCE 0.100 MILLIMETERS UNLESS OTHERWISE SPECIFIED.
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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.